

SCAN16512

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SCAN16512 Low Voltage Universal 16-bit IEEE 1149.1 Bus Transceiver with TRI-STATE Outputs

Check for Samples: SCAN16512

FEATURES

- IEEE 1149.1 (JTAG) Compliant
- 2.7V to 3.6V V_{CC} Operation
- TRI-STATE outputs for bus-oriented applications
- Dual byte-wide data for bus applications
- Power down high Impedance inputs and outputs
- Optional Bus Hold on data inputs eliminates

- the need for external pullup/pulldown resistors (SCANH16512, SCANH162512 versions)
- Optional 25Ω series resistors in outputs to minimize noise and eliminate termination resistors (SCAN162512, SCANH162512 versions)
- Supports live insertion/withdrawal
- Includes CLAMP and HIGHZ instructions

DESCRIPTION

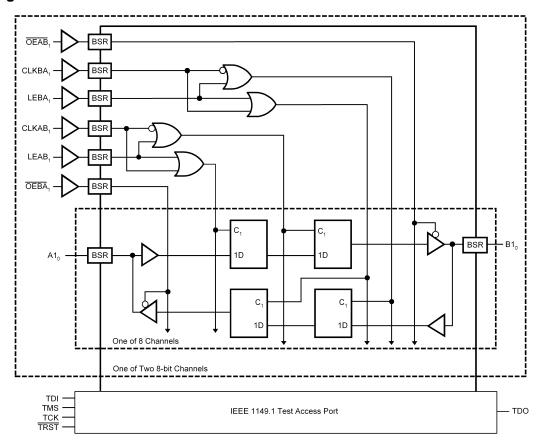
The SCAN16512 is a high speed, low-power universal bus transceiver featuring data inputs organized into two 8-bit bytes with output enable and latch enable control signals. This function is configurable as a D-type Latch or Flip-Flop, and can operate in transparent, latched, or clocked mode. This device is compliant with IEEE 1149.1 Standard Test Access Port and Boundary Scan Architecture with the incorporation of the defined boundary-scan test logic and test access port consisting of Test Data Input (TDI), Test Data Out (TDO), Test Mode Select (TMS), Test Clock (TCK), and Test Reset (TRST).

A

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Block Diagram



Pin Functions

Pin Descriptions

| Pin Name | Description |
|--|---|
| A1 ₀ -A1 ₇ ,A2 ₀ - A2 ₇ | Normal-function A-bus I/O ports. See function table for normal-mode logic. |
| B1 ₀ -B1 ₇ ,B2 ₀ - B2 ₇ | Normal-function B-bus I/O ports. See function table for normal-mode logic. |
| CLKAB ₁ , CLKBA ₁ , CLKAB ₂ , CLKBA ₂ | Normal-function clock inputs.See function table for normal-mode logic. |
| GND | Ground |
| V _{CC} | Supply Voltage |
| LEAB ₁ , LEBA ₁ , LEAB ₂ , LEBA ₂ | Normal-function latch enables. See function table for normal-mode logic. |
| OEAB ₁ , OEBA ₁ , OEAB ₂ , OEBA ₂ | Normal-function output enables. See function table for normal-mode logic. |
| TDO | The Test Data Output to support IEEE Std 1149.1-1990. TDO is the serial output for shifting data through the instruction register or selected data register. |
| TMS | The Test Mode Select input to support IEEE Std 1149.1-1990. TMS directs the device through it's TAP controller states. An internal pull-up forces TMS high if left unconnected. |
| TCK | The Test Clock input to support IEEE Std 1149.1-1990. Test operations of the device are synchronous to TCK. Data is captured on the rising edge of TCK and outputs change on the falling edge of TCK. |

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Pin Descriptions (continued)

| | Pin Name | Description | |
|---|----------|--|--|
| Т | DI | The Test Data Input to support IEEE Std 1149.1-1990. TDI is the serial input to shift data through the instruction register or the selected data register. An internal pull-up resistor forces TDI high if left unconnected. | |
| T | RST | The Test Reset Input to support IEEE Std 1149.1-1990. TRST is the asynchronous reset pin which will force the TAP controller to it's initialization state when active. An internal pullup resistor forces TRST high if left unconnected. | |

BGA Pinout

| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
|---|--------------------|--------------------|-------------------|-------------------|-----------------|--------------------|-------------------|-------------------|
| Α | A1 ₀ | A1 ₂ | A1 ₄ | A1 ₆ | A2 ₀ | A2 ₂ | A2 ₄ | A2 ₆ |
| В | A1 ₁ | A1 ₃ | A1 ₅ | A1 ₇ | A2 ₁ | A2 ₃ | A2 ₅ | A2 ₇ |
| С | TRST | CLKAB ₁ | LEAB ₁ | OEAB ₁ | GND | CLKAB ₂ | LEAB ₂ | OEAB ₂ |
| D | TMS | GND | V _{CC} | GND | V _{CC} | GND | TDI | TDO |
| E | TCK | GND | V _{CC} | V _{CC} | GND | GND | N/C | V _{CC} |
| F | CLKBA ₁ | LEBA ₁ | OEBA ₁ | GND | N/C | CLKBA ₂ | LEBA ₂ | OEBA ₂ |
| G | B1 ₁ | B1 ₃ | B1 ₅ | B1 ₇ | B2 ₁ | B2 ₃ | B2 ₅ | B2 ₇ |
| Н | B1 ₀ | B1 ₂ | B1 ₄ | B1 ₆ | B2 ₀ | B2 ₂ | B2 ₄ | B2 ₆ |

Connection Diagram

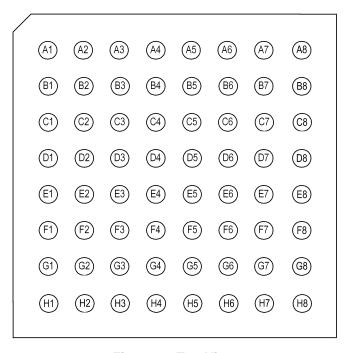


Figure 1. Top View

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Truth Table (1)(2)(3) Function Table (2)

NSTRUMENTS

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| | Outputs | | | |
|------|---------|----------|---|-------------------------------|
| OEAB | LEAB | CLKAB | Α | В |
| L | L | L | X | B ₀ ⁽³⁾ |
| L | L | ↑ | L | L |
| L | L | ↑ | Н | Н |
| L | Н | X | L | L |
| L | Н | X | Н | Н |
| Н | X | Х | Х | Z |

- (1) H = HIGH Voltage Level
 - L = LOW Voltage Level
 - X = Immaterial (HIGH or LOW, inputs may not float)
 - Z = High Impedance
- A-to-B data flow is shown. B-to-A data flow is similar, but uses OEBA, LEBA, and CLKBA.
- Output level before the indicated steady-state input conditions were established.

Functional Description

In the normal mode, these devices are 16-bit universal bus transceivers that combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, or clocked modes. They can be used as two 8-bit transceivers, or as one 16-bit transceiver. The test circuitry can be activated by the TAP to take snapshot samples of the data appearing at the device pins or to perform a self test on the boundary-test cells. Activating the TAP may affect the normal functional operation of the universal bus transceivers. When the TAP is activated, the test circuitry performs boundary-scan test operations according to the protocol described in IEEE Std 1149.1-1990.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched while CLKAB is held at a static low or high logic level. Otherwise, if LEAB is low, A data is stored on a low-to-high transition of CLKAB. When OEAB is LOW, the B outputs are active. When OEAB is HIGH, the B outputs are in the high-impedance state. B-to-A data flow is similar to A-to-B data flow but uses the OEBA, LEBA, and CLKBA inputs.

Five dedicated test pins are used to observe and control the operation of the test circuitry: test data input (TDI), test data output (TDO), test mode select (TMS), test clock (TCK), and test reset (TRST). All testing and scan operations are synchronized to the TAP interface.

For details about the sequence of boundary scan cells in the SCAN16512, please refer to the BSDL (Boundary Scan Description Language) file available on our website.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings (1)

| Supply Voltage (V _{CC}) | -0.5V to +4.6V |
|---|----------------------|
| DC Input Diode Current (I _{IK}) | |
| $V_{i} = -0.5V$ | −50 mA |
| DC Output Diode Current (I _{OK}) | |
| $V_{O} = -0.5V$ | -50 mA |
| DC Input Voltage (V _I) | -0.5V to 4.6V |
| DC Output Voltage (V _O) | -0.5V to 4.6V |
| DC Output Source/Sink Current (I _O) | ±50 mA |
| DC V _{CC} or Ground Current | |
| Per Supply Pin | ±100 mA |
| Junction Temperature | +150°C |
| Storage Temperature | −65°C to +150°C |
| Lead Temperature (Solder, 4sec) | |
| 64L BGA | 220 °C |
| Thermal Resistance | |
| BGA θ _{JA} | 62°C/W |
| Package Derating | 16.1mW/°C above 25°C |
| ESD (Min) | 1000V |

⁽¹⁾ Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of SCAN circuits outside databook specifications.

Recommended Operating Conditions

| Supply Voltage (V _{CC}) | |
|---|----------------|
| SCAN16512 | 2.7V to 3.6V |
| Input Voltage (V _I) | 0V to 3.6V |
| Output Voltage (V _O) | 0V to 3.6V |
| Operating Temperature (T _A) | |
| Industrial | −40°C to +85°C |

Product Folder Links: SCAN16512

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DC Electrical Characteristics

| | | | Indu | ıstrial | Mili | itary | | |
|------------------|---|------------------------|--|---------|----------------------------------|-------|-------|--|
| Symbol | Parameter | V _{CC} (V) | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | | T _A = -55°C to +125°C | | Units | Conditions |
| | | (*) | Min | Max | Min | Max | | |
| V _{IH} | Minimum High Input Voltage | 2.7 | 2.0 | | 2.0 | | V | V _{OUT} = 0.1V |
| | | 3.6 | 2.0 | | 2.0 | | | or V _{CC} -0.1V |
| V _{IL} | Maximum Low Input Voltage | 2.7 | | 0.8 | | 0.8 | V | V _{OUT} = 0.1V |
| | | 3.6 | | 0.8 | | 0.8 | | or V _{CC} -0.1V |
| V _{OH} | Minimum High Output Voltage | 2.7 | 2.5 | | 2.5 | | V | I _{OUT} = −100 |
| | All Outputs, All Options | 3.6 | 3.4 | | 3.4 | | | μΑ |
| | Minimum High Output Voltage TDO Outputs, All Options | 2.7 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OH} = -12mA$ |
| | | 3.0 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} = -24\text{mA}$ |
| | Minimum High Output Voltage A and B Ports: SCAN16512 and SCANH16512 options | 2.7 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -12mA$ |
| | | 3.0 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -24$ mA |
| | Minimum High Output Voltage A and B Ports: SCAN162512 and SCANH162512 options (25Ω series | 2.7 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -4mA$ |
| | resistor options) | 3.0 | 2.2 | | 2.2 | | V | $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -12mA$ |
| V _{OL} | Maximum Low Output Voltage | 2.7 | | 0.2 | | 0.2 | V | I _{OUT} = 100 μA |
| | All Outputs, All Options Maximum Low Output Voltage TDO Outputs, All Options | 3.6 | | 0.2 | | 0.2 | | |
| | | 2.7 | | 0.4 | | 0.4 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 12mA$ |
| | | 3.0 | | 0.55 | | 0.55 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 24mA$ |
| | Maximum Low Output Voltage A and B Ports: SCAN16512 and SCANH16512 Options | 2.7 | | 0.4 | | 0.4 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 12mA$ |
| | | 3.0 | | 0.55 | | 0.55 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 24mA$ |
| | Maximum Low Output Voltage A and B Ports: SCAN162512 and SCANH162512 Options (25Ω | 2.7 | | 0.4 | | 0.4 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 4mA$ |
| | series resistor options) | 3.0 | | 0.6 | | 0.6 | V | $V_{IN} = V_{IL}$ or V_{IH} , $I_{OL} = 12mA$ |
| I _{IN} | Maximum Input Leakage Current | 3.6 | | ±5.0 | | ±5.0 | μA | V _I = V _{CC} , GND |
| I _{ILR} | Input Low Current | 3.6 | | -200 | | -200 | μA | V _{IN} = GND |
| l _{OZ} | Maximum I/O Leakage Current | 3.6 | | ±5.0 | | ±5.0 | | V _I (OE) = V _{IL} , V _{IH} |
| | | | | | | | μA | $V_{I} = V_{CC},$ GND $V_{O} = V_{CC},$ |
| | | | | | | | | V _O = V _{CC} , GND |

SNLS150C -MAY 2004-REVISED OCTOBER 2011

DC Electrical Characteristics (continued)

| | | | Industrial V _{CC} T _A = -40°C to +85°C | | Military T _A = −55°C to +125°C | | Units | |
|----------------------|--|------------------------|--|-------|---|-------|-------|---|
| Symbol | Parameter | V _{CC} (V) | | | | | | Conditions |
| | | (•) | Min | Max | Min | Max | | |
| I _{I(HOLD)} | Bus Hold Input Minimum Drive Hold Current ⁽¹⁾ | 2.7 | ±75 | | ±75 | | μA | V _I = 0.8V or 2.0V |
| | | 3.6 | | ±625 | | ±625 | | $V_{I} = 0 \text{ to } 3.6V$ |
| V _{IKL} | Input Clamp Diode Voltage | 2.7 | | -1.5 | | -1.5 | V | I _{IN} = -18mA |
| I _{OFF} | Power-off Leakage Current | 0.0 | | ±10.0 | | ±10.0 | μA | V _O = V _{CC} , GND |
| I _{CC} | Maximum Quiescent Supply Current | 3.6 | | 20 | | 20 | μA | |
| I _{CCt} | Maximum I _{CC} Per Input | 3.6 | | 0.5 | | 0.5 | mA | V _I = V _{CC} -0.6V |

⁽¹⁾ Applies to devices with Bus Hold feature only.

Noise Specifications

Applies to SCAN16512 and SCANH16512 options, $C_L = 30pF$, $R_L = 500\Omega$ to GND

| | | | Industrial, Military | | |
|------------------|--------------------------------------|------------------------|-----------------------|-------|--|
| Symbol | Parameter | V _{CC} (V) | T _A = 25°C | Units | |
| | | (•) | Typical Limits | | |
| V _{OLP} | Quiet Output Maximum Dynamic VOL (1) | 3.3 | 1.2 | V | |
| V _{OLV} | Quiet Output Minimum Dynamic VOL (1) | 3.3 | -1.5 | V | |
| V _{OHP} | Quiet Output Maximum Dynamic VOH (2) | 3.3 | VOH + 0.9 | V | |
| V _{OHV} | Quiet Output Minimum Dynamic VOH (2) | 3.3 | VOH - 1.5 | V | |

⁽¹⁾ Maximum number of outputs is defined as n. (n-1) outputs are switched LOW while the quiet output is monitored in a LOW (VOL) state. Also, (n-1) outputs are switched HIGH while the quiet output is monitored in a LOW (VOL) state.

Noise Specifications

Applies to SCAN162512 and SCANH162512 options, $C_L = 30 pF$, $R_L = 500 \Omega$ to GND

| | | | Industrial, Military | | |
|------------------|---|------------------------|----------------------|-------|--|
| Symbol | Parameter | V _{CC} (V) | $T_A = 25^{\circ}C$ | Units | |
| | | (•) | Typical Limits | | |
| V _{OLP} | Quiet Output Maximum Dynamic VOL (1) | 3.3 | 0.6 | V | |
| V _{OLV} | Quiet Output Minimum Dynamic VOL (1) | 3.3 | -0.5 | V | |
| V _{OHP} | Quiet Output Maximum Dynamic VOH ⁽²⁾ | 3.3 | VOH + 0.5 | V | |
| V _{OHV} | Quiet Output Minimum Dynamic VOH (2) | 3.3 | VOH - 0.6 | V | |

⁽¹⁾ Maximum number of outputs is defined as n. (n-1) outputs are switched LOW while the quiet output is monitored in a LOW (VOL) state.

Also, (n-1) outputs are switched HIGH while the quiet output is monitored in a LOW (VOL) state.

Product Folder Links: SCAN16512

⁽²⁾ Maximum number of outputs is defined as n. (n-1) outputs are switched LOW while the quiet output is monitored in a HIGH (VOH) state.

Also, (n-1) outputs are switched HIGH while the quiet output is monitored in a HIGH (VOH) state.

⁽²⁾ Maximum number of outputs is defined as n. (n-1) outputs are switched LOW while the quiet output is monitored in a HIGH (VOH) state. Also, (n-1) outputs are switched HIGH while the quiet output is monitored in a HIGH (VOH) state.





AC Electrical Characteristics

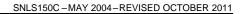
Normal Operation, over recommended operating supply voltage and temperature ranges unless otherwise specified.

| | | SCAN16512, | SCAN16512, SCANH16512 | | SCANH16512 | Units |
|--------------------|------------------------------------|-----------------------|-----------------------|---|------------|-------|
| | | T _A = −40° | C to +85°C | $T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $C_L = 30 \text{ pF}$ $R_L = 500\Omega \text{ to GND}$ | | |
| Symbol | Parameter | | 30 pF Ω to GND | | | |
| | | Min | Max | Min | Max | |
| t _{PLH} , | Propagation Delay | | 5.5 | | 6.5 | ns |
| t _{PHL} | A to B, B to A | | 5.5 | | 6.5 | |
| t _{PLH} , | Propagation Delay | | 6.0 | | 7.0 | ns |
| t _{PHL} | CLKAB to B, CLKBA to A | | 6.0 | | 7.0 | |
| t _{PLH} , | Propagation Delay | | 6.0 | | 7.0 | ns |
| t _{PHL} | LEAB to B, LEBA to A | | 6.0 | | 7.0 | |
| t _{PLZ} , | Disable Time, OEAB to B, OEBA to A | | 7.5 | | 8.0 | ns |
| t _{PHZ} | | | 7.5 | | 8.0 | |
| t _{PZL} , | Enable Time, OEAB to B, OEBA to A | | 7.5 | | 8.0 | ns |
| t _{PZH} | | | 7.5 | | 8.0 | |

AC Electrical Characteristics

Normal Operation, over recommended operating supply voltage and temperature ranges unless otherwise specified.

| | | SCAN | 1162512 | SCAN162512 $T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $C_L = 30 \text{ pF}$ $R_L = 500\Omega \text{ to GND}$ | | Units |
|--------------------|------------------------------------|-----------------------|-------------------|--|-----|-------|
| | | T _A = −40° | C to +85°C | | | |
| Symbol | Parameter | | 30 pF Ω to GND | | | |
| | | Min | Max | Min | Max | |
| t _{PLH} , | Propagation Delay | | 6.0 | | 7.0 | ns |
| t _{PHL} | A to B, B to A | | 6.0 | | 7.0 | |
| t _{PLH} , | Propagation Delay | | 6.5 | | 7.5 | ns |
| t _{PHL} | CLKAB to B, CLKBA to A | | 6.5 | | 7.5 | |
| t _{PLH} , | Propagation Delay | | 6.5 | | 7.5 | ns |
| t _{PHL} | LEAB to B, LEBA to A | | 6.5 | | 7.5 | |
| t _{PLZ} , | Disable Time, OEAB to B, OEBA to A | | 7.5 | | 8.0 | ns |
| t _{PHZ} | | | 7.5 | | 8.0 | |
| t _{PZL} , | Enable Time, OEAB to B, OEBA to A | | 7.5 | | 8.0 | ns |
| t _{PZH} | | | 7.5 | | 8.0 | |



AC Electrical Characteristics

ISTRUMENTS

Normal Operation, over recommended operating supply voltage and temperature ranges unless otherwise specified.

| Symbol | Parameter | SCANH162512 $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $C_L = 30 \text{ pF}$ $R_L = 500\Omega \text{ to GND}$ | | SCANH162512 $T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $C_L = 30 \text{ pF}$ $R_L = 500\Omega \text{ to GND}$ | | Units | | | | | |
|--------------------|------------------------------------|--|----------------|---|-----|-------|--------------------|-------------------|-----|-----|--|
| | | | | | | | Min | Max | Min | Max | |
| | | | | | | | t _{PLH} , | Propagation Delay | | 6.0 | |
| | | t _{PHL} | A to B, B to A | | 6.0 | | 7.0 | | | | |
| t _{PLH} , | Propagation Delay | | 6.5 | | 7.5 | ns | | | | | |
| t _{PHL} | CLKAB to B, CLKBA to A | | 6.5 | | 7.5 | | | | | | |
| t _{PLH} , | Propagation Delay | | 6.5 | | 7.5 | ns | | | | | |
| t _{PHL} | LEAB to B, LEBA to A | | 6.5 | | 7.5 | | | | | | |
| t _{PLZ} , | Disable Time, OEAB to B, OEBA to A | | 7.5 | | 8.0 | ns | | | | | |
| t _{PHZ} | | | 7.5 | | 8.0 | | | | | | |
| t _{PZL} , | Enable Time, OEAB to B, OEBA to A | | 8.0 | | 8.0 | ns | | | | | |
| t _{PZH} | | | 8.0 | | 8.0 | | | | | | |

AC Operating Requirements

Normal Operation, over recommended operating supply voltage and temperature ranges unless otherwise specified

| Symbol | | All Options | All Options | Units |
|------------------|--|---|---|-------|
| | | T _A = -40°C to +85°C | T _A = −55°C to +125°C | |
| | Parameter | $C_L = 30 \text{ pF},$ $R_L = 500\Omega \text{ to GND}$ | $C_L = 30 \text{ pF},$ $R_L = 500\Omega \text{ to GND}$ | |
| | | Guaranteed Minimum | Guaranteed Minimum | |
| t _S | Setup Time, A to CLKAB or B to CLKBA | 1.5 | 1.5 | ns |
| t _H | Hold Time, A to CLKAB or B to CLKBA | 2.0 | 2.0 | ns |
| t _S | Setup Time, A to LEAB or B to LEBA | 1.5 | 1.5 | ns |
| t _H | Hold Time, A to LEAB or B to LEBA | 2.5 | 2.5 | ns |
| t _W | Pulse Width, CLKAB or CLKBA, high or low | 2.0 | 2.0 | ns |
| t _W | Pulse Width, LEAB or LEBA high | 2.0 | 2.0 | ns |
| f _{max} | Maximum CLKAB or CLKBA Clock Frequency | 250 | 250 | MHz |

AC Operating Requirements

can Test Operation, over recommended operating supply voltage and temperature ranges unless otherwise specified

| Symbol | | All Options | All Options | Units |
|------------------|--------------------------------|---|---|-------|
| | Parameter | T _A = −40°C to +85°C | T _A = -55°C to +125°C | |
| | | $C_L = 30 \text{ pF},$ $R_L = 500\Omega \text{ to GND}$ | $C_L = 30 \text{ pF},$ $R_L = 500\Omega \text{ to GND}$ | |
| | | Guaranteed Minimum | Guaranteed Minimum | |
| t _S | Setup Time, H or L, TMS to TCK | 2.0 | 2.0 | ns |
| t _H | Hold Time, H or L, TCK to TMS | 1.0 | 1.0 | ns |
| t _S | Setup Time, H or L, TDI to TCK | 1.0 | 1.0 | ns |
| t _H | Hold Time, H or L, TCK to TDI | 2.0 | 2.0 | ns |
| t _W | Pulse Width TCK High or Low | 10 | 10 | ns |
| t _W | Pulse Width TRST, Low | 2.5 | 2.5 | ns |
| f _{max} | Maximum TCK Clock Frequency | 25 | 25 | MHz |
| t _{REC} | Recovery Time, TRST to TCK | 2.0 | 2.0 | ns |

Product Folder Links: SCAN16512



TEST CIRCUIT DIAGRAMS

AC Loading and Waveforms

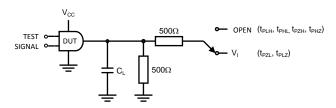
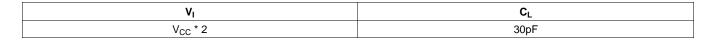


Figure 2. AC Test Circuit (C_L includes probe and jig capacitance)



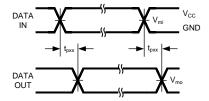


Figure 3. Waveform for Inverting and Non-inverting Functions

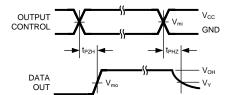


Figure 4. Tristate Output High Enable and Disable Times for Logic

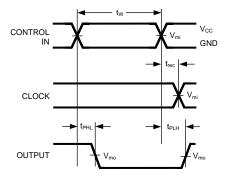
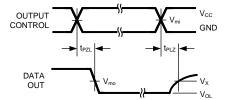


Figure 5. Propagation Delay, Pulse Width and t_{REC} Waveforms



Tristate Output Low Enable and Disable Times for Logic

Figure 6. Timing Waveforms (Input Characteristics; f = 1MHz, $t_r = t_f = 2.5ns$)

| Symbol | V _{CC} 2.7 - 3.6V | | |
|-----------------|----------------------------|--|--|
| V | | | |
| V_{mi} | 1.5V | | |
| V _{mo} | 1.5V | | |
| V _x | V _{OL} + 0.3V | | |
| V_{y} | V _{OH} - 0.3V | | |

CAPACITANCE AND I/O CHARACTERISTICS

Refer to National's website for IBIS models at http://www.national.com/scan

Device ID Register

| Ordering Code | Features | Device ID | Manufacturer & LSB |
|---------------|---|-----------|--------------------|
| SCAN16512SM | No bus hold, no series resistor | FC30 | 01F |
| SCANH16512SM | With bus hold only | FC31 | 01F |
| SCAN162512SM | With 25Ω series resistors in outputs | FC32 | 01F |
| SCANH162512SM | With 25Ω series resistors and bus hold | FC33 | 01F |

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